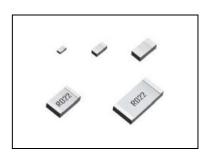
Thick film shunt resistors <face down type>

UCR series

Datasheet

Features

- 1) Very-low ohmic resistance from $11m\Omega$ is in lineup by thick-film resistive element.
- 2) Resistive element is located at bottom side, which reduces the resistance shift during mounting process.
- 3) ROHM's unique structure achieved improvement of heat.
- 4) ROHM resistors have obtained ISO9001 / IATF16949 certification.
- 5) Corresponds to AEC-Q200.UCR03 (under $100m\Omega$ or less) are unsupprted.



Products list

Part No.	Si.	ze	Rated Power	Resistance tolerance	Temperature coefficient	Resistance r	ange	Operating temperature						
	(mm)	(inch)	(70°C) (W)		(ppm/°C)	(Ω)		range (°C)						
UCR006	0603	0201	0.1	F(±1%) J(±5%)	0~300	0.100≦R<1	(E24series)	-55 ~+ 155	Yes					
					0~300	0.068≦R<0.100	88≦R<0.100 (E24series)							
UCR01	R01 1005 0402	0402	0402	0402	0402	0402	0402	0.125	125 F(±1%) J(±5%)	0~250	0.100≦R<0.220	(E24series)	-55 ~ +155	Yes
				0(2070)	0~200	0.220≦R≦0.910	(E24series)	´ 						
				= (. 40()	0~250	0.020≦R<0.050	(E24series)	-55 ~+155						
			0.25	F(±1%) J(±5%)	0~200	0.050≦R<0.100	(E24series)							
UCR03	1608	0603		0 (2070)	0~150	0.100≦R≦0.200	(E24series)		Yes*					
			0.2	F (±1%) J (±5%)	0~150	0.220≦R≦0.910	(E24series)							
				E / 140/)	250±200	0.011≦R<0.020	(E24series)							
UCR10	2012	0805	0.33	F(±1%) J(±5%)	0~250	0.020≦R≦0.047	(E24series)	-55 ~ +155						
				- (/ -	0~150	0.047 <r≦0.1< td=""><td>(E24series)</td><td>-55 ~+155 -55 ~+155</td><td></td></r≦0.1<>	(E24series)	-55 ~+155 -55 ~+155						
			0.5	F(±1%)	0~350	0.011≦R<0.020	(E24series)							
UCR18	3216	1206	(★1)	J(±5%)	0~200	0.020≦R≦0.039	(E24series)	-55 ~+155	Yes					
			0.5	. ,	0~150	0.039 <r≦0.1< td=""><td>(E24series)</td><td></td><td></td></r≦0.1<>	(E24series)							

Design and specifications are subject to change without notice.
 Carefully check the specification sheet supplied with the product before using or ordering it.
 UCR03 correspounds only to 100m Ω or more.

 \bigstar :Under development

Part Number Description



Part No.

UCR

shunt

type)

(Thick film

resistors

face down



006 (0603 [0201])

01 (1005 [0402])

03 (1608 [0603])

10 (2012 [0805])

18 (3216 [1206])

Size (mm[inch])



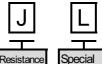
UCR18

EVH

Packaging specifications code							
Part No.	Code	Packaging specifications	Quantity / Reel				
UCR006	YVP	Paper tape (2mmPitch)	15,000				
UCR01	MP	Paper tape (2mm Pitch)	10,000				
UCR03	EWP (20mΩ~47mΩ)	Paper tape	5,000				
22.100	EVP (51mΩ~910mΩ)	(4mm Pitch)	5,500				
UCR10	EVH	Paper tape (4mm Pitch)	5,000				

Paper tape

(4mm Pitch)

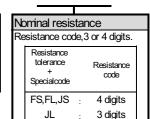


tolerance

F (±1%)

J (±5%)



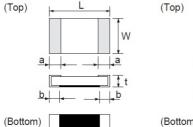


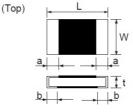
5,000

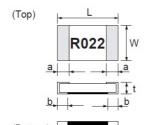
Chip resistor dimensions and markings



■ UCR03(50mΩ \leq R \leq 910mΩ)







<Marking method>
There are three or four digits used for the calculation number according to IEC code and "R"is used for the decimal point.

Ex.) 4digits·····0.1 Ω =R100 3digits·····0.1 Ω =R10

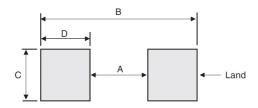




(Unit:mm)

Part No.	(mm)	(inch)	L	W	t	а	b	Marking existence
UCR006	0603	0201	0.62±0.05	0.32±0.05	0.24±0.05	0.18±0.10	0.22±0.10	No
UCR01	1005	0402	1.00±0.10	0.55±0.10	0.37±0.05	0.28±0.10	0.34±0.10	No
UCR03	1608	0603	1.60±0.10	0.87 ±0.10	0.50±0.10	0.45±0.20	0.45±0.20	No
UCR10	2012	0805	2.00±0.10	1.25±0.10	0.55±0.10	0.24±0.20	0.50±0.20	Yes
UCR18	3216	1206	3.20±0.15	1.60 ±0.15	0.55±0.10	0.30±0.20	0.90±0.25	Yes

•Land pattern example



(Unit:mm)

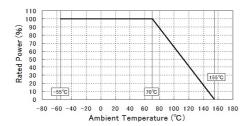
Dimensions Part No.	А	В	С	D
UCR006	0.3	0.84	0.3	0.27
UCR01	0.5	1.8	0.5	0.65
UCR03	0.5	2.5	0.9	1.0
UCR10	0.8	3.4	1.3	1.3
UCR18	1.4	4.0	1.8	1.3

UCR series Datasheet

Derating curve

When the ambient temperature exceeds 70°C, power dissipation must be adjusted according to the derating curves below.

■UCR006/01/03/10/18



Characteristics

Test items	Guaranteed value	Test conditions
Resistance	See P.1	20°C Measuring method : Measure Bottom termination by 4 proves. Bottom termination prove
Variation of resistance with temperature	See P.1	Measurement: +25/-55, +25/+125°C
Overload	±2.0%	Rated voltage(current)×2.5, 2s
Solderability	Anew uniform coating of minimum of 95% of the surface being immersed and no soldering damage.	Rosin-ethanol solution (25% mass) Soldering condition: 245±5°C Duration of immersion: 2.0±0.5s
Resistance to soldering heat	±1.0% No remarkable abnormality on the appearance.	Soldering condition: 260±5°C Duration of immersion: 10±1s
Rapid change of temperature	±1.0%	Test temp:-55°C~+125°C 5cycles
Damp heat, steady state	±3.0%	40°C, 93%(Relative humidity) Test time: 1,000h
Endurance at 70°C	±3.0%	70°C,Rated voltage 1.5h:ON – 0.5h:OFF Test time: 1,000h
Endurance	±3.0%	155°C Test time: 1,000h
Resistance to solvent	±0.5%	23±5°C, Immersion cleaning, 5±0.5min Solvent: 2-propanol
Bend strength of the end face plating	Without open.	-

^{*}Please contact us for guarantee of the test conditions other than those described above.

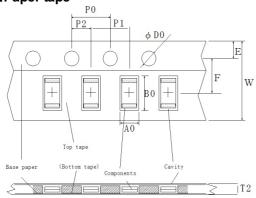
Compliance Standard(s): IEC60115-8

JIS C 5201-1



●Tape dimensions

■Paper tape

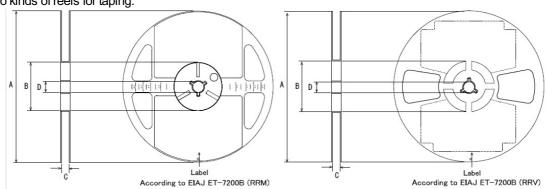


					(Unit:mm)
Part No.	W	F	Е	A0	B0
UCR006	8.0±0.1	3.5±0.05	1.75±0.03	0.39±0.02	0.7±0.02
UCR01	8.0±0.3	3.5±0.05	1.75±0.1	0.7±0.1	1.2±0.10
UCR03	8.0±0.3	3.5±0.05	1.75±0.1	1.1±0.1	1.9±0.1
UCR10	8.0±0.3	3.5±0.05	1.75±0.1	1.65 ^{+0.2} _{-0.1}	2.4 ^{+0.2} -0.1
UCR18	8.0±0.3	3.5±0.05	1.75±0.1	1.95 ^{+0.1} _{-0.05}	3.5 ^{+0.15} _{-0.05}

Part No.	D0	P0	P1	P2	T2
UCR006	Ф1.5±0.03	4.0±0.1	2.0±0.05	2.0±0.05	MAX 0.46
UCR01	Ф1.5 ^{+0.1}	4.0±0.1	2.0±0.05	2.0±0.05	MAX1.1
UCR03	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.05	2.0±0.05	MAX1.1
UCR10	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
UCR18	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1

Reel dimensions

Using two kinds of reels for taping.



-				(Unit:mm)
Part No.	Α	В	С	D
UCR006				
UCR01	0	11.0	14.0	
UCR03	Ф180 ⁰ -1.5	Ф60 ^{+1.0}	9 ^{+1.0}	Ф13±0.2
UCR10	-1.5	O	O	
UCR18				

Notice

Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA	
CLASSIII	CL ACCIT	CLASS II b	CL A C C TT	
CLASSIV	CLASSⅢ	CLASSIII	CLASSⅢ	

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

General Precaution

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- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
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>>ROHM Semiconductor(罗姆)